

Vishay General Semiconductor

AUTOMOTIVE

RoHS

COMPLIANT

HALOGEN FREE

Ultrafast Avalanche SMD Rectifier



SMA (DO-214AC)



ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	2.0 A			
V_{RRM}	50 V, 100 V, 200 V			
I _{FSM}	35 A			
I _R	1.0 μΑ			
V _F at I _F	1.1 V			
t _{rr}	25 ns			
E _R	20 mJ			
T _J max.	150 °C			
Package	SMA (DO-214AC)			
Circuit configurations	Single			

FEATURES

- Low profile package
- Ideal for automated placement
- · Glass passivated pellet chip junction
- · Low reverse current
- Low forward voltage
- Soft recovery characteristic
- Ultra fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHE3 or P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified Base P/NHM3_X - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,...)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3, M3, HE3, and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	BYG22A	BYG22B	BYG22D	UNIT
Device marking code		BYG22A	BYG22B	BYG22D	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	V
Average forward current	I _{F(AV)}	2.0			Α
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	35			А
Pulse energy in avalanche mode, non repetitive (inductive load switch off) I _{(BR)R} = 1 A, T _J = 25 °C	E _R	20			mJ
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150			°C

BYG22A, BYG22B, BYG22D

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYG22A	BYG22B	BYG22D	UNIT
Maximum instantaneous	I _F = 1.0 A	T _ 25 °C	$T_{J} = 25 ^{\circ}\text{C}$ $V_{F}^{(1)}$ -	1.0			V
forward voltage	I _F = 2.0 A	1) = 25 C		1.1			\ \ \ \ \
Maximum reverse current	V - V	T _J = 25 °C	,	1			μΑ
	$V_R = V_{RRM}$	T _J = 100 °C	I _R	10			
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	25		ns	

Note

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	BYG22A BYG22B BYG22D			UNIT
Maximum thermal resistance, junction to lead, T _L = const.	$R_{ heta JL}$	25			°C/W
Maximum thermal resistance, junction to ambient	R _{0JA} (1)	150			
	R _{0JA} (2)	125		°C/W	
	R _{0JA} (3)		100		

Notes

- (1) Mounted on epoxy-glass hard tissue
- (2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- (3) Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 µm Cu

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
BYG22D-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYG22D-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYG22DHE3_A/H (1)	0.064	Н	1800	7" diameter plastic tape and reel	
BYG22DHE3_A/I (1)	0.064	I	7500	13" diameter plastic tape and reel	
BYG22D-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYG22D-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYG22DHM3_A/H (1)	0.064	Н	1800	7" diameter plastic tape and reel	
BYG22DHM3_A/I (1)	0.064	I	7500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

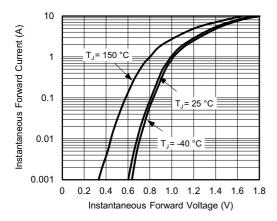


Fig. 1 - Forward Current vs. Forward Voltage

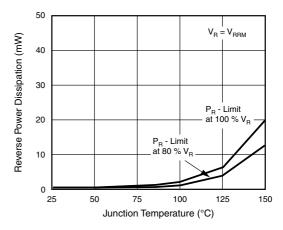


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

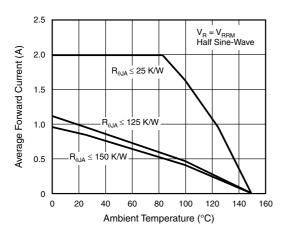


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

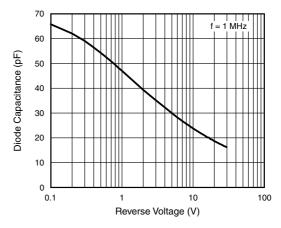


Fig. 5 - Diode Capacitance vs. Reverse Voltage

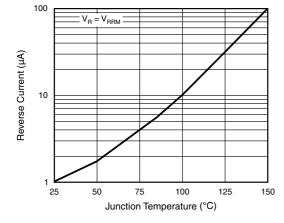


Fig. 3 - Reverse Current vs. Junction Temperature

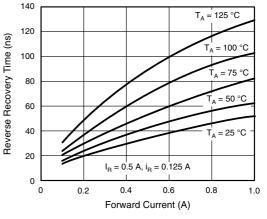


Fig. 6 - Max. Reverse Recovery Time vs. Forward Current



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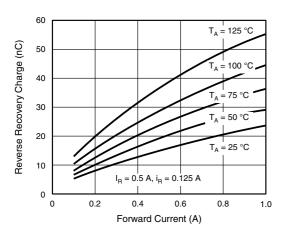


Fig. 7 - Max. Reverse Recovery Charge vs. Forward Current

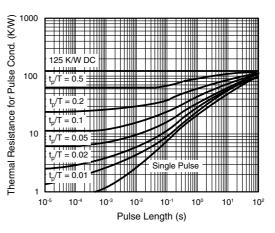
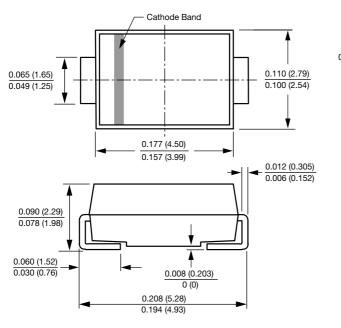
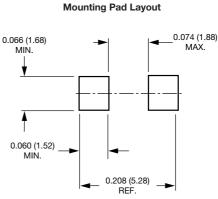


Fig. 8 - Thermal Response

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMA (DO-214AC)







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